



PRODUCT IDENTIFICATION

JRPI	0402	M	- 100	M
Type	Size	Control	Inductance	Tol.

FEATURES

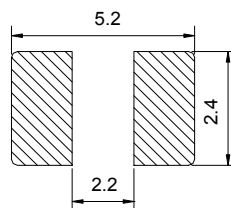
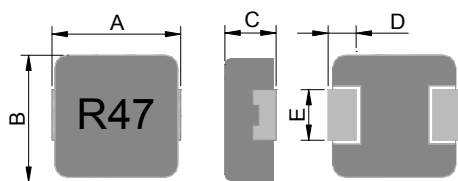
1. Carbonyl powder inductor.
2. Compact design.
3. High current , low DCR , high efficiency.
4. Very low acoustic noise and very low leakage flux noise.
5. High reliability.
6. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
7. Operating temperature -40~+125°C (Including self - temperature rise)

APPLICATIONS

Note PC power system , incl. IMVP-6
DC/DC converter .

DIMENSIONS (mm)

Recommend PC Board Pattern



Note:

1. The above PCB layout reference only.
2. Recommend solder paste thickness at 0.12mm and above.

Part No.	Size (mm)				
	A	B	C	D	E
JRPI 0402M	4.45 ± 0.25	4.06 ± 0.25	1.8 ± 0.2	0.76 ± 0.3	2.0 ± 0.2

SERIES LIST

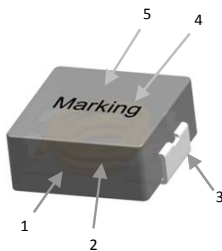
No.	Part No.	L (μH)	TOL. (%)	RDC (mΩ)		I sat (A)	
				Typ.	Max.	Typ.	Typ.
1	JRPI 0402M-R10N	0.10	±30	3.2	4.0	35.0	12.0
2	JRPI 0402M-R18N	0.18	±30	4.6	5.4	28.0	13.5
3	JRPI 0402M-R22N	0.22	±30	6.6	7.3	24.0	13.0
4	JRPI 0402M-R33M	0.33	±20	7.8	8.6	18.0	10.0
5	JRPI 0402M-R47M	0.47	±20	11.2	14	12.0	8.0
6	JRPI 0402M-R56M	0.56	±20	13.5	16	10.0	7.3
7	JRPI 0402M-R68M	0.68	±20	16	19	10.0	7.0
8	JRPI 0402M-1R0M	1.00	±20	22	27	8.5	5.0
9	JRPI 0402M-1R2M	1.20	±20	25	30	7.8	4.8
10	JRPI 0402M-1R5M	1.50	±20	35	42	7.0	4.5
11	JRPI 0402M-2R2M	2.20	±20	51	61	6.0	4.0
12	JRPI 0402M-3R3M	3.30	±20	69	76	4.0	3.5
13	JRPI 0402M-4R7M	4.70	±20	95	105	3.5	2.6
14	JRPI 0402M-5R6M	5.60	±20	112	125	3.0	2.2
15	JRPI 0402M-6R8M	6.80	±20	150	172	2.8	2.1
16	JRPI 0402M-8R2M	8.20	±20	158	180	2.5	2.0
17	JRPI 0402M-100M	10.0	±20	215	243	2.3	1.8

18	JRPI 0402M-150M	15.0	±20	325	374	1.9	1.5
19	JRPI 0402M-220M	22.0	±20	470	500	1.4	1.2

Note:

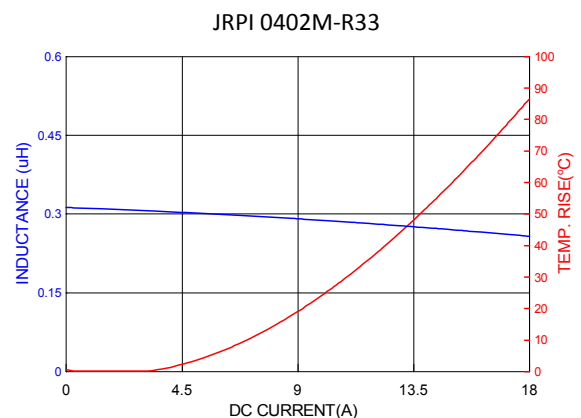
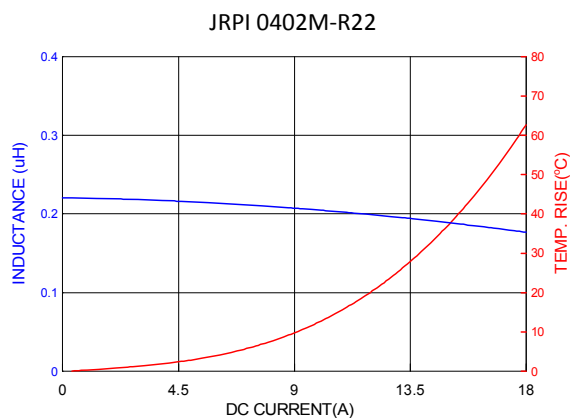
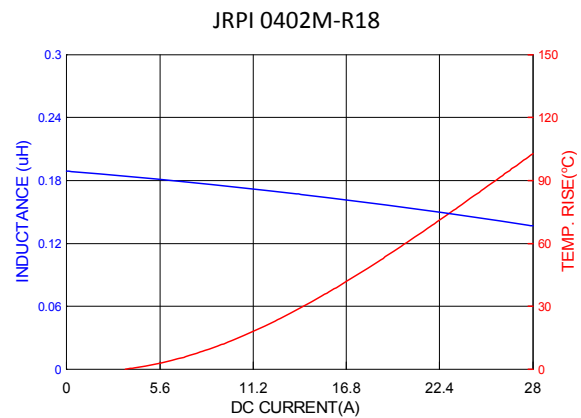
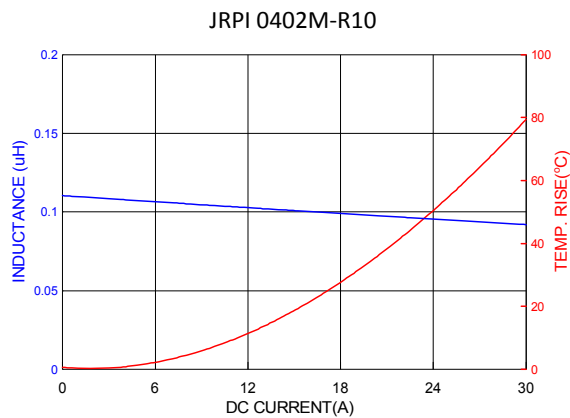
1. Test Frequency: 100KHz /1V
2. All test data referenced to 25°C ambient
3. Saturation Current (Isat) will cause L0 to drop approximately 30%.
4. Heat Rated Current (Irms) will cause the coil temperature rise approximately ΔT of 40°C
5. The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions.
Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
6. Special inquiries besides the above common used types can be met on your requirement.

Materials

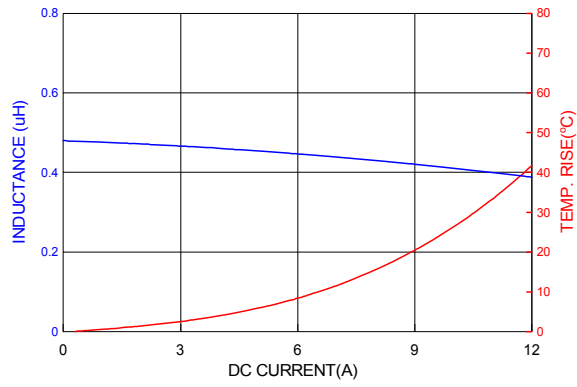


NO	Items	Materials
1	Core	Carbonyl Powder
2	Wire	Polyester Wire or equivalent.
3	Solder Plating	100% Pb free solder(Ni+Sn)
4	Ink	Halogen-free ketone
5	paint	Epoxy resin

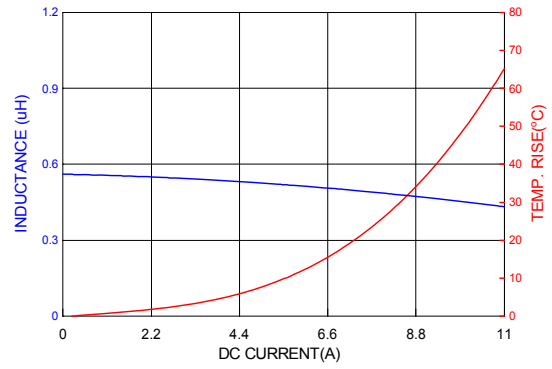
TYPICAL PERFORMANCE CURVES



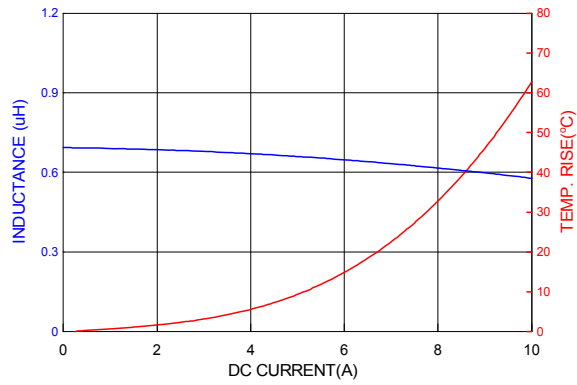
JRPI 0402M-R47



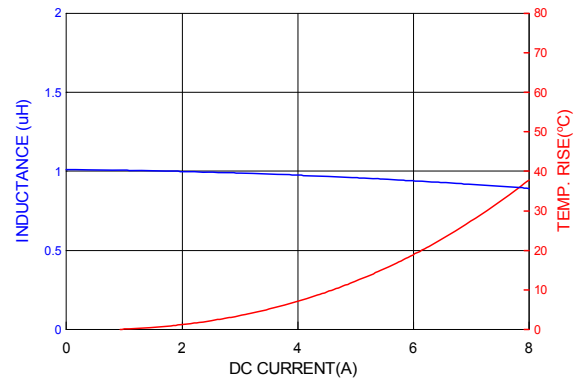
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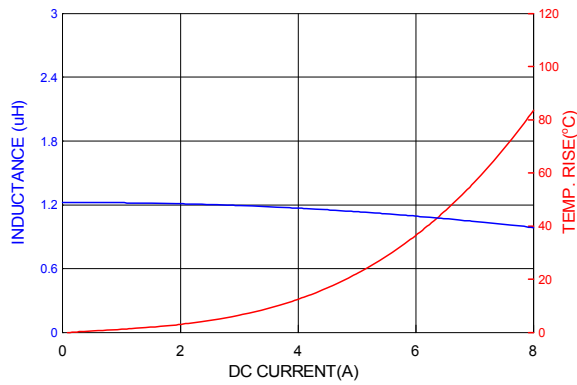
JRPI 0402M-R68



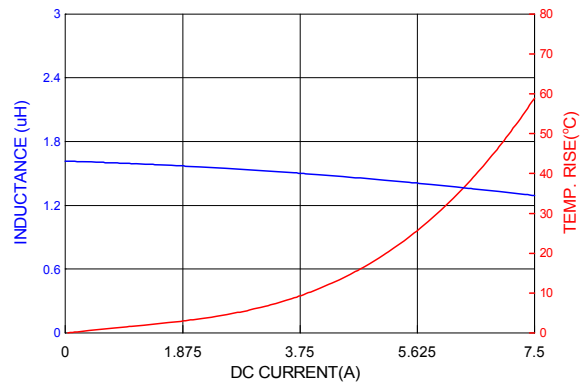
JRPI 0402M-1R0



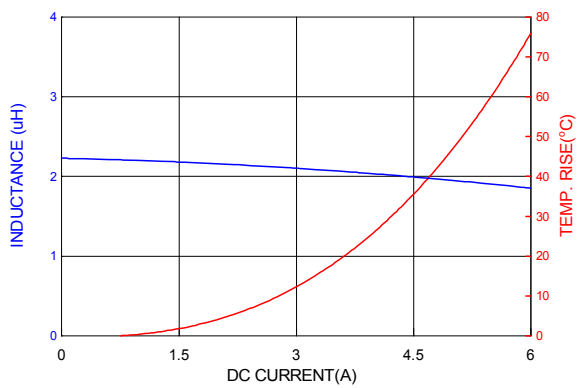
JRPI 0402M-1R2



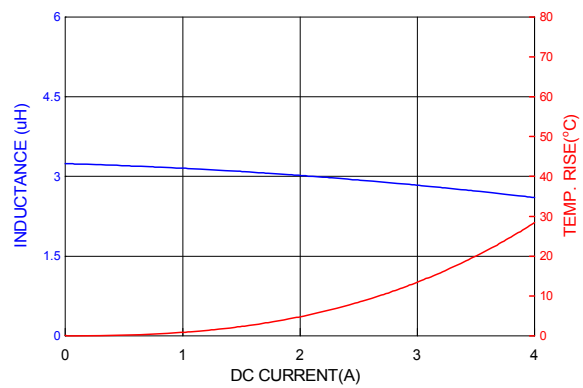
JRPI 0402M-1R5



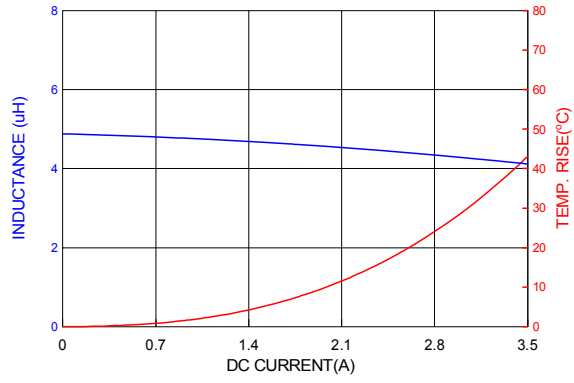
JRRI 0402M-2R2



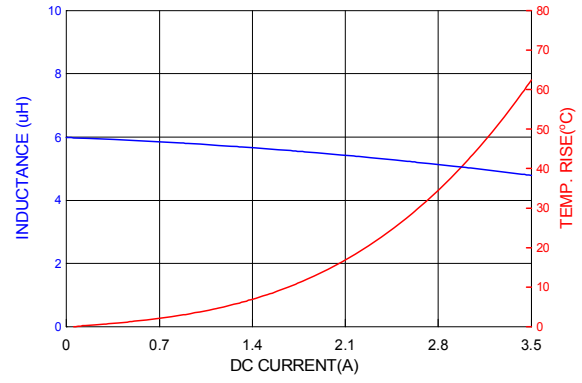
JRRI 0402M-3R3



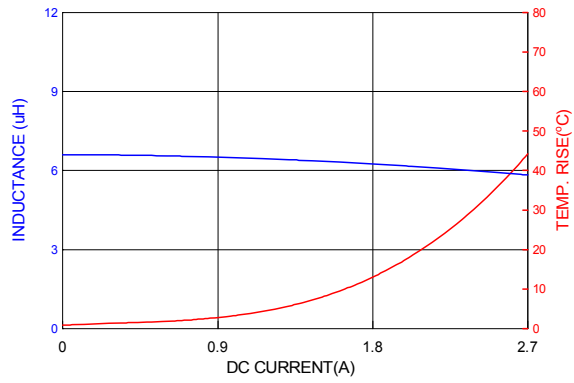
JRRI 0402M-4R7



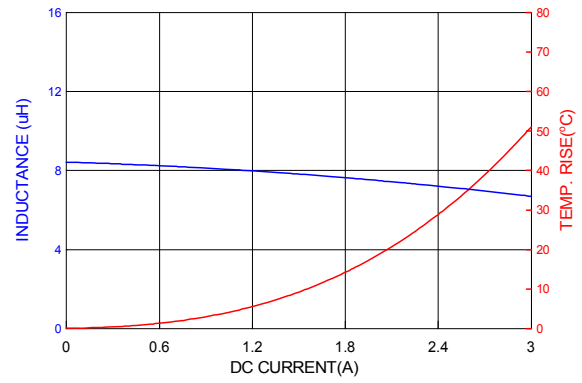
JRRI 0402M-5R6



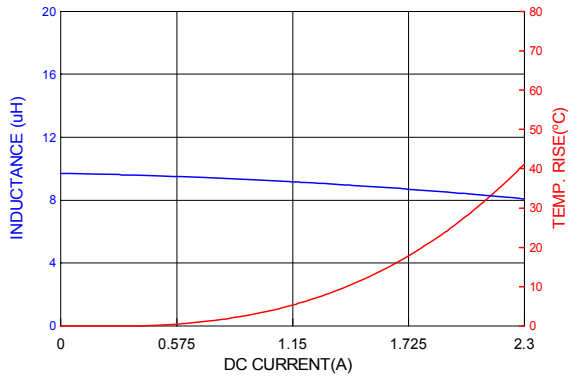
JRRI 0402M-6R8



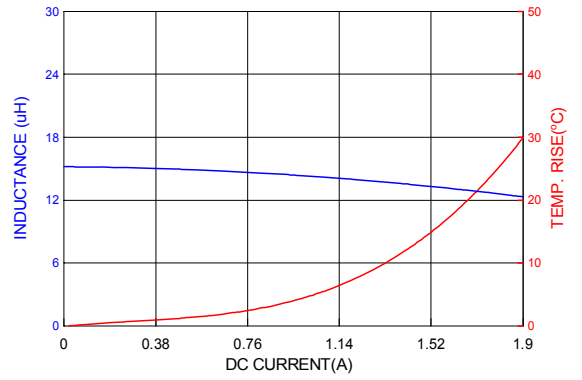
JRRI 0402M-8R2



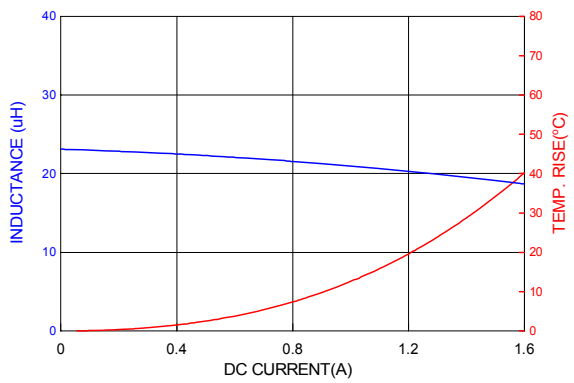
JRRI 0402M-100



JRRI 0402M-150

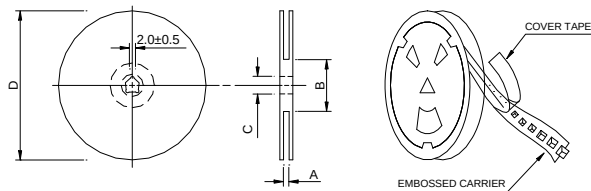


JRRI 0402M-220



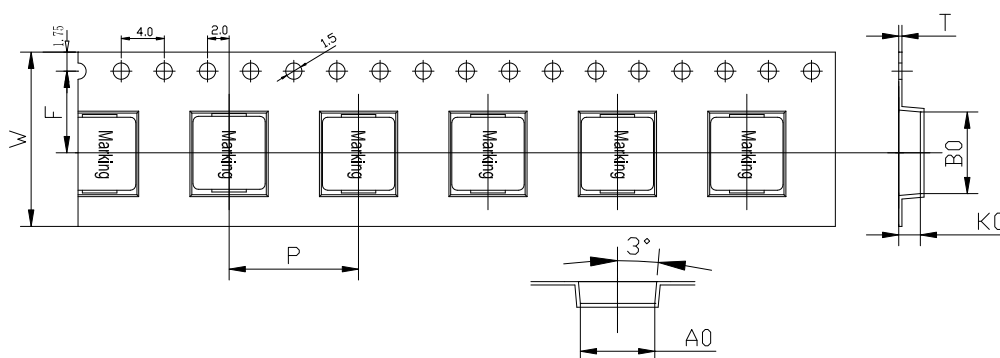
Packaging Information

• Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
13"x12mm	12.4+2/-0	100±2	13+0.5/-0.2	330

• Tape Dimension

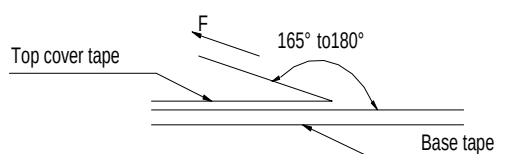


Ao(mm)	Bo(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)
4.4±0.1	5.0±0.1	2.3±0.1	8.0±0.1	12±0.3	5.5±0.1	0.35±0.05

• Packaging Quantity

Size	Reel	Inner box	Carton
JRPI 0402M	3000	6000	24000

• Tearing Off Force



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions (referenced ANSI/EIA-481-C-2003 of 4.11 standard)

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

■ Application Notice

- Storage Conditions(component level)

To maintain the solderability of terminal electrodes:

1. Products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
2. Temperature and humidity conditions: Less than 40°C and 60% RH.
3. Recommended products should be used within 12 months form the time of delivery.
4. The packaging material should be kept where no chlorine or sulfur exists in the air.

- Transportation

1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
3. Bulk handling should ensure that abrasion and mechanical shock are minimized.